



74ALVCH16600

18-bit universal bus transceiver; 3-state

Rev. 4 — 4 July 2024

Product data sheet

1. General description

The 74ALVCH16600 is an 18-bit universal transceiver with bus hold inputs and 3-state outputs. Data flow in each direction is controlled by output enable (\overline{OEAB} and \overline{OEBA}), latch enable (LEAB and LEBA), clock enable (\overline{CEAB} and \overline{CEBA}) and clock (\overline{CPAB} and \overline{CPBA}) inputs. For A-to-B data flow, the device operates in the transparent mode when LEAB is HIGH. When LEAB is LOW, the A data is latched if CPAB is held at a HIGH or LOW logic level. If LEAB and \overline{CEAB} are LOW, the A-bus data is stored in the latch/flip-flop on the HIGH-to-LOW transition of \overline{CPAB} . When OEAB is HIGH, the outputs are active. When OEAB is LOW, the outputs are in the high-impedance state.

Data flow for B-to-A is similar to that of A-to-B but uses \overline{OEBA} , LEBA, \overline{CEBA} and \overline{CPBA} . This device is fully specified for partial power down applications using I_{OFF} . The I_{OFF} circuitry disables the output, preventing the potentially damaging backflow current through the device when it is powered down.

2. Features and benefits

- Wide supply voltage range from 1.65 V to 3.6 V
- CMOS low power dissipation
- MULTIBYTE™ flow-through standard pin-out architecture
- Low inductance multiple V_{CC} and GND pins for minimum noise and ground bounce
- Direct interface with TTL levels (2.7 V to 3.6 V)
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- Bus hold on data inputs
- Output drive capability 50 Ω transmission lines at 85 °C
- Current drive ± 24 mA at 3.0 V
- Complies with JEDEC standards:
 - JESD8-7 (1.65 V to 1.95 V)
 - JESD8-5 (2.3 V to 2.7 V)
 - JESD8C (2.7 V to 3.6 V)
- ESD protection:
 - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
 - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Specified from -40 °C to +85 °C

3. Ordering information

Table 1. Ordering information

| Type number | Package | | | |
|---------------------------------|-------------------|---------|--|--------------------------|
| | Temperature range | Name | Description | Version |
| 74ALVCH16600DGG | -40 °C to +85 °C | TSSOP56 | plastic thin shrink small outline package; 56 leads; body width 6.1 mm | SOT364-1 |

4. Functional diagram

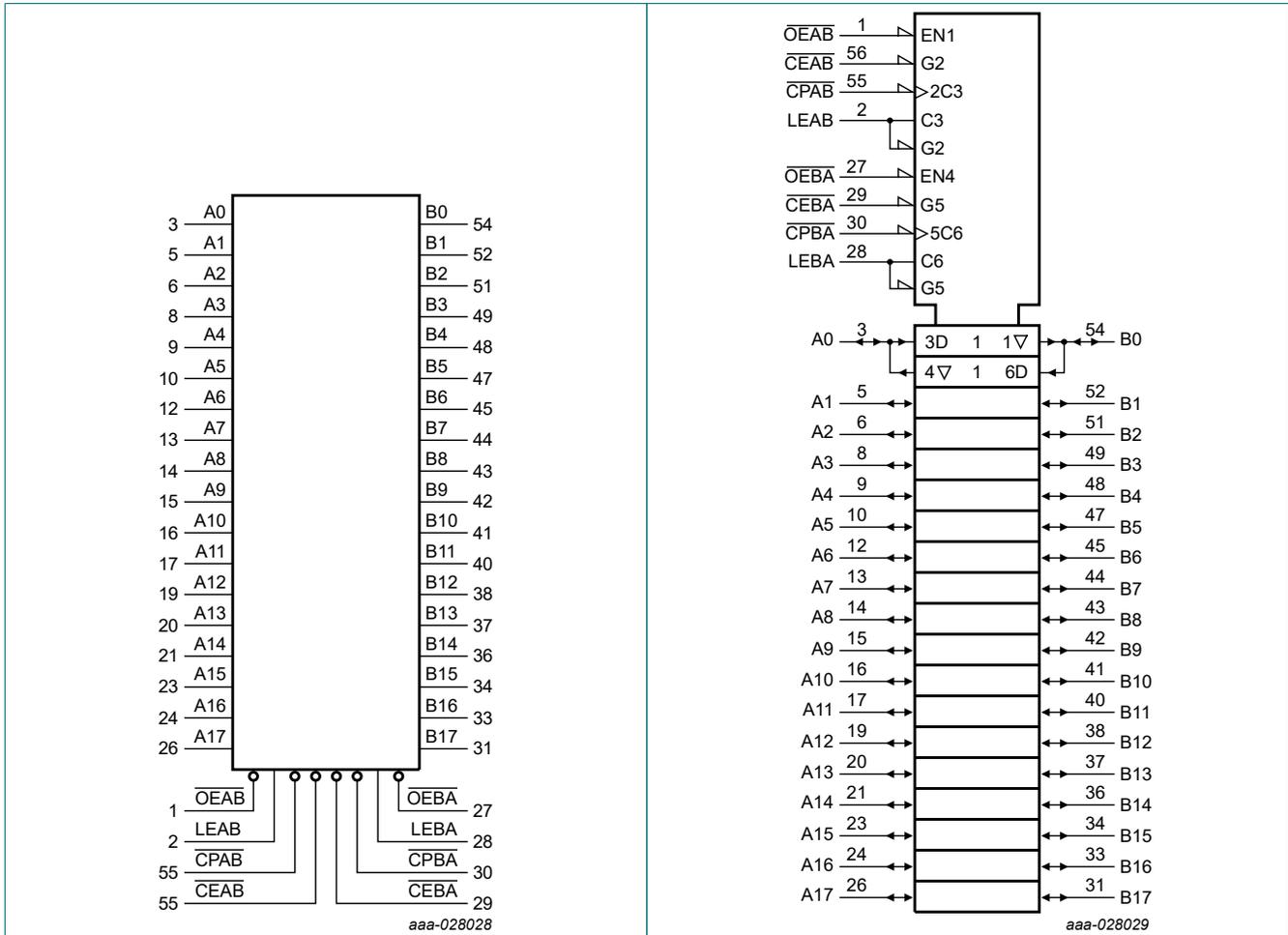


Fig. 1. Logic symbol

Fig. 2. IEC logic symbol

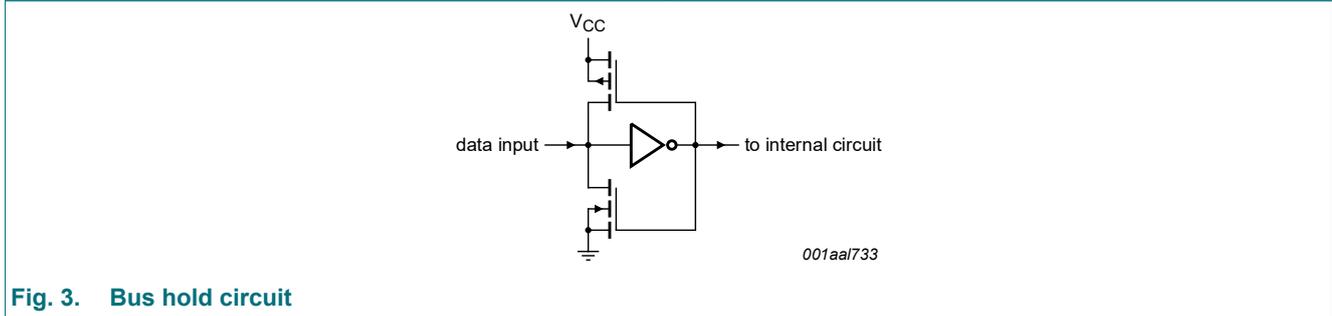
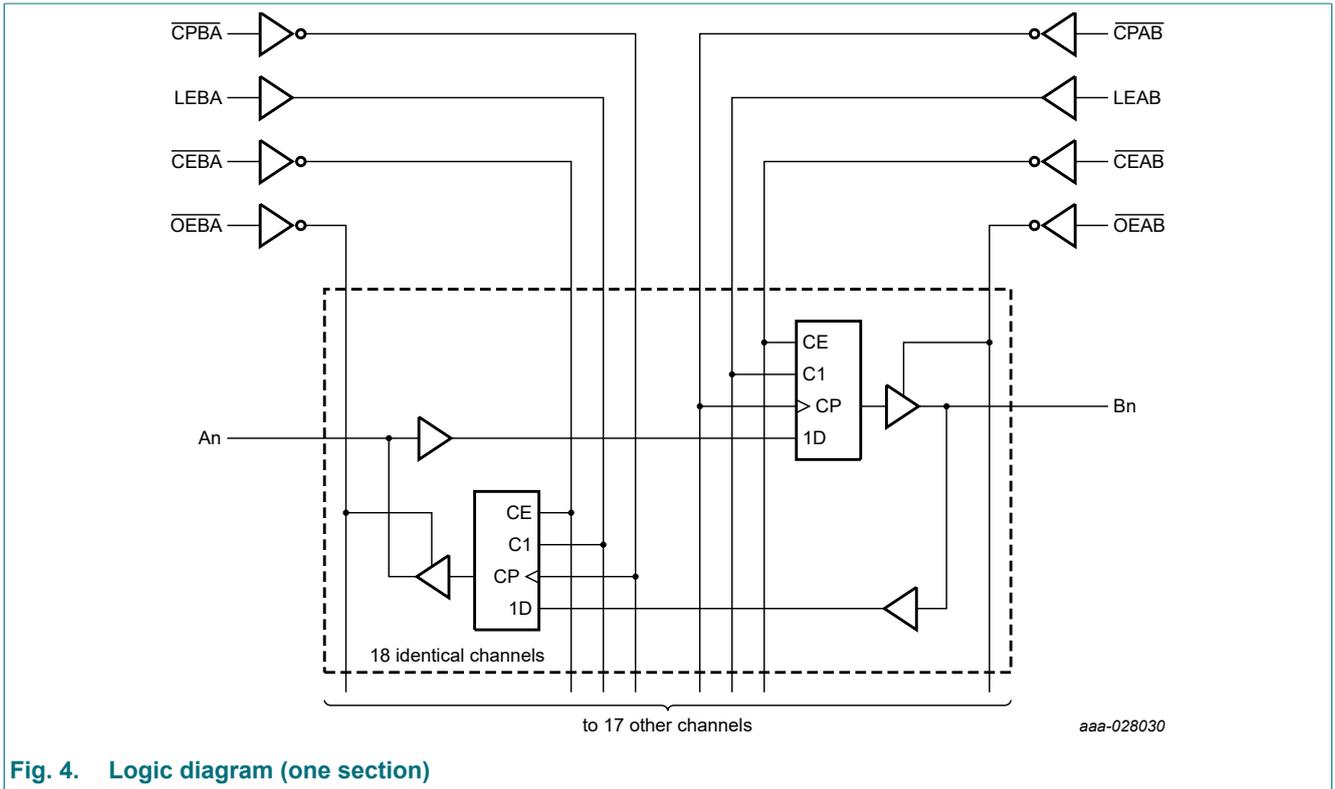
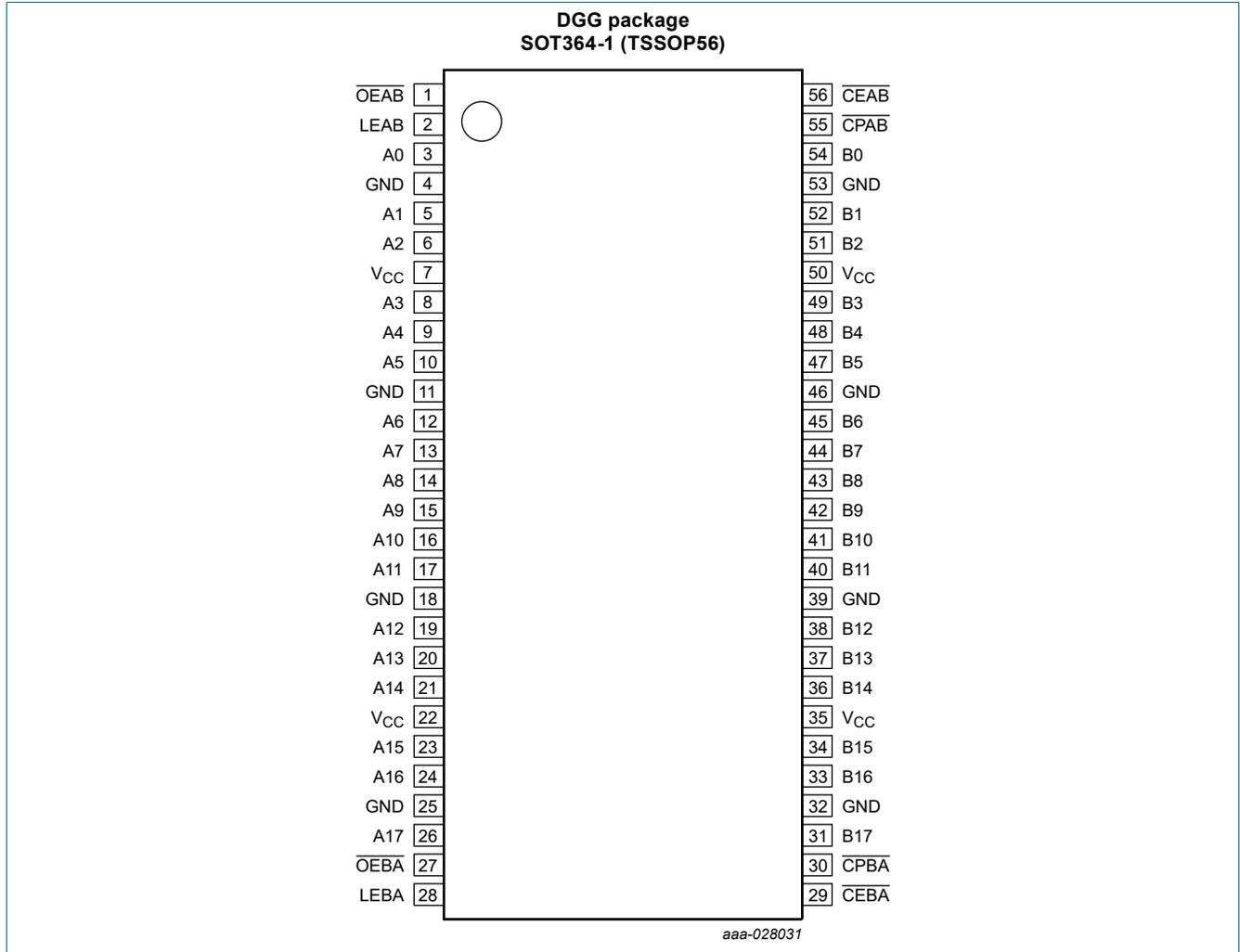


Fig. 3. Bus hold circuit



5. Pinning information

5.1. Pinning



5.2. Pin description

Table 2. Pin description

| Symbol | Pin | Description |
|--|--|---|
| A0, A1, A2, A3, A4, A5, A6, A7, A8, A9, A10, A11, A12, A13, A14, A15, A16, A17 | 3, 5, 6, 8, 9, 10, 12, 13, 14, 15, 16, 17, 19, 20, 21, 23, 24, 26 | data inputs/outputs |
| B0, B1, B2, B3, B4, B5, B6, B7, B8, B9, B10, B11, B12, B13, B14, B15, B16, B17 | 54, 52, 51, 49, 48, 47, 45, 44, 43, 42, 41, 40, 38, 37, 36, 34, 33, 31 | data outputs/inputs |
| OEAB, OEBA | 1, 27 | A to B / B to A output enable input (active LOW) |
| LEAB, LEBA | 2, 28 | A to B / B to A latch enable inputs (active HIGH) |
| CPBA, CPAB | 30, 55 | B to A / A to B clock inputs (active LOW) |
| CEBA, CEAB | 29, 56 | B to A / A to B clock enable inputs (active LOW) |
| GND | 4, 11, 18, 25, 32, 39, 46, 53 | ground (0 V) |
| V _{CC} | 7, 22, 35, 50 | supply voltage |

6. Functional description

Table 3. Function selection

A-to-B data flow is shown; B-to-A flow is similar but uses \overline{CEBA} , \overline{OEBA} , LEBA, and \overline{CPBA} .

H = HIGH voltage level; h = HIGH voltage level one set-up time prior to the enable or clock transition;

L = LOW voltage level; l = LOW voltage level one set-up time prior to the enable or clock transition;

X = don't care; NC = no change; Z = high-impedance OFF-state;

↓ = HIGH-to-LOW enable or clock transition.

| Operating mode | Inputs | | | | | Outputs |
|----------------------|--------|------|------|------|----|---------|
| | CEAB | OEAB | LEAB | CPAB | An | Bn |
| Disabled | X | H | X | X | X | Z |
| Transparent | X | L | H | X | H | H |
| | X | L | H | X | L | L |
| Hold | H | L | L | X | X | NC |
| Clock data & Display | L | L | L | ↓ | h | H |
| | L | L | L | ↓ | l | L |
| Hold data & Display | L | L | L | H | X | NC |
| | L | L | L | L | X | NC |

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------|-------------------------|-------------------------------|------|----------------|------|
| V_{CC} | supply voltage | | -0.5 | +4.6 | V |
| V_I | input voltage | data inputs [1] | -0.5 | $V_{CC} + 0.5$ | V |
| | | control inputs [1] | -0.5 | +4.6 | V |
| V_O | output voltage | [1] | -0.5 | $V_{CC} + 0.5$ | V |
| I_{IK} | input clamping current | $V_I < 0$ V | -50 | - | mA |
| I_{OK} | output clamping current | $V_O > V_{CC}$ or $V_O < 0$ V | - | ± 50 | mA |
| I_O | output current | $V_O = 0$ V to V_{CC} | - | ± 50 | mA |
| I_{CC} | supply current | | - | 100 | mA |
| I_{GND} | ground current | | -100 | - | mA |
| T_{stg} | storage temperature | | -65 | +150 | °C |
| P_{tot} | total power dissipation | $T_{amb} = -40$ °C to +85 °C | - | 500 | mW |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

8. Recommended operating conditions

Table 5. Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Max | Unit |
|---------------------|-------------------------------------|--|-----|----------|------|
| V_{CC} | supply voltage | for maximum speed performance at $C_L = 30$ pF | 2.3 | 2.7 | V |
| | | for maximum speed performance at $C_L = 50$ pF | 3.0 | 3.6 | V |
| V_I | input voltage | | 0 | V_{CC} | V |
| V_O | output voltage | | 0 | V_{CC} | V |
| T_{amb} | ambient temperature | in free air | -40 | +85 | °C |
| $\Delta t/\Delta V$ | input transition rise and fall rate | $V_{CC} = 2.3$ V to 3.0 V | 0 | 20 | ns/V |
| | | $V_{CC} = 3.0$ V to 3.6 V | 0 | 10 | ns/V |

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | -40 °C to +85 °C | | | Unit |
|-------------------|---------------------------------|---|-----------------------|------------------------|------|------|
| | | | Min | Typ [1] | Max | |
| V _{IH} | HIGH-level input voltage | V _{CC} = 2.3 to 2.7 V | 1.7 | 1.2 | - | V |
| | | V _{CC} = 2.7 to 3.6 V | 2.0 | 1.5 | - | V |
| V _{IL} | LOW-level input voltage | V _{CC} = 2.3 to 2.7 V | - | 1.2 | 0.7 | V |
| | | V _{CC} = 2.7 to 3.6 V | - | 1.5 | 0.8 | V |
| V _{OH} | HIGH-level output voltage | V _I = V _{IH} or V _{IL} | | | | |
| | | I _O = -100 μA; V _{CC} = 2.3 V to 3.6 V | V _{CC} - 0.2 | V _{CC} | - | V |
| | | I _O = -6 mA; V _{CC} = 2.3 V | V _{CC} - 0.3 | V _{CC} - 0.08 | - | V |
| | | I _O = -12 mA; V _{CC} = 2.3 V | V _{CC} - 0.6 | V _{CC} - 0.26 | - | V |
| | | I _O = -12 mA; V _{CC} = 2.7 V | V _{CC} - 0.5 | V _{CC} - 0.14 | - | V |
| | | I _O = -12 mA; V _{CC} = 3.0 V | V _{CC} - 0.6 | V _{CC} - 0.09 | - | V |
| | | I _O = -24 mA; V _{CC} = 3.0 V | V _{CC} - 1.0 | V _{CC} - 0.28 | - | V |
| V _{OL} | LOW-level output voltage | V _I = V _{IH} or V _{IL} | | | | |
| | | I _O = 100 μA; V _{CC} = 2.3 V to 3.6 V | - | GND | 0.20 | V |
| | | I _O = 6 mA; V _{CC} = 2.3 V | - | 0.07 | 0.40 | V |
| | | I _O = 12 mA; V _{CC} = 2.3 V | - | 0.15 | 0.70 | V |
| | | I _O = 12 mA; V _{CC} = 2.7 V | - | 0.14 | 0.40 | V |
| | | I _O = 24 mA; V _{CC} = 3.0 V | - | 0.27 | 0.55 | V |
| I _I | input leakage current | V _I = V _{CC} or GND; V _{CC} = 2.3 V to 3.6 V | - | 0.1 | 5 | μA |
| I _{BHL} | bus hold LOW current | V _{CC} = 2.3 V; V _I = 0.7 V | 45 | - | - | μA |
| | | V _{CC} = 3.0 V; V _I = 0.8 V | 75 | 150 | - | μA |
| I _{BHH} | bus hold HIGH current | V _{CC} = 2.3 V; V _I = 1.7 V | -45 | - | - | μA |
| | | V _{CC} = 3.0 V; V _I = 2.0 V | -75 | -175 | - | μA |
| I _{BHLO} | bus hold LOW overdrive current | V _{CC} = 3.6 V | 500 | - | - | μA |
| I _{BHHO} | bus hold HIGH overdrive current | V _{CC} = 3.6 V | -500 | - | - | μA |
| I _{OZ} | OFF-state output current | V _{CC} = 2.7 V to 3.6 V; V _I = V _{IH} or V _{IL} ; V _O = V _{CC} or GND | - | 0.1 | 10 | μA |
| I _{CC} | supply current | V _{CC} = 2.3 to 3.6 V; V _I = V _{CC} or GND; I _O = 0 A | - | 0.2 | 40 | μA |
| ΔI _{CC} | additional supply current | V _I = V _{CC} - 0.6 V; I _O = 0 A; V _{CC} = 2.3 V to 3.6 V | - | 150 | 750 | μA |
| C _I | input capacitance | | - | 4.0 | - | pF |
| C _{I/O} | input/output capacitance | | - | 8.0 | - | pF |

[1] All typical values are measured at T_{amb} = 25 °C.

10. Dynamic characteristics

Table 7. Dynamic characteristics

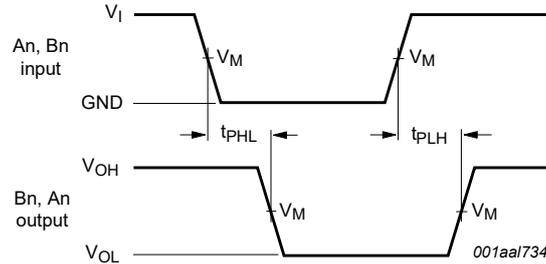
Voltages are referenced to GND (ground = 0 V); for test circuit, see Fig. 9.

| Symbol | Parameter | Conditions | -40 °C to +85 °C | | | Unit |
|-----------|-------------------|---|------------------|---------|-----|------|
| | | | Min | Typ [1] | Max | |
| t_{pd} | propagation delay | An to Bn; Bn to An; Fig. 5 [2] | | | | |
| | | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$ | 1.0 | 3.1 | 5.2 | ns |
| | | $V_{CC} = 2.7\text{ V}$ | - | 3.1 | 4.7 | ns |
| | | $V_{CC} = 3.0\text{ V to }3.6\text{ V}$ | 1.0 | 2.8 | 4.2 | ns |
| | | LEAB to Bn; LEBA to An; Fig. 6 [2] | | | | |
| | | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$ | 1.0 | 3.6 | 6.2 | ns |
| | | $V_{CC} = 2.7\text{ V}$ | - | 3.4 | 5.5 | ns |
| | | $V_{CC} = 3.0\text{ V to }3.6\text{ V}$ | 1.0 | 3.1 | 4.9 | ns |
| | | CPAB to Bn; CPBA to An; Fig. 6 [2] | | | | |
| | | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$ | 1.0 | 3.8 | 7.3 | ns |
| | | $V_{CC} = 2.7\text{ V}$ | - | 3.8 | 6.8 | ns |
| | | $V_{CC} = 3.0\text{ V to }3.6\text{ V}$ | 1.3 | 2.9 | 5.7 | ns |
| t_{en} | enable time | OEAB to Bn; OEBA to An; Fig. 7 [2] | | | | |
| | | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$ | 1.0 | 3.1 | 6.5 | ns |
| | | $V_{CC} = 2.7\text{ V}$ | - | 3.3 | 6.3 | ns |
| | | $V_{CC} = 3.0\text{ V to }3.6\text{ V}$ | 1.1 | 2.8 | 5.2 | ns |
| t_{dis} | disable time | OEAB to Bn; OEBA to An; Fig. 7 [2] | | | | |
| | | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$ | 1.0 | 2.8 | 5.1 | ns |
| | | $V_{CC} = 2.7\text{ V}$ | - | 3.3 | 4.7 | ns |
| | | $V_{CC} = 3.0\text{ V to }3.6\text{ V}$ | 1.2 | 3.2 | 4.4 | ns |
| t_w | pulse width | LEAB HIGH; LEBA HIGH; Fig. 6 | | | | |
| | | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$ | 3.3 | 1.6 | - | ns |
| | | $V_{CC} = 2.7\text{ V}$ | 3.3 | 1.0 | - | ns |
| | | $V_{CC} = 3.0\text{ V to }3.6\text{ V}$ | 3.3 | 1.0 | - | ns |
| | | CPAB HIGH or LOW; CPBA HIGH or LOW; Fig. 6 | | | | |
| | | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$ | 3.3 | 2.0 | - | ns |
| | | $V_{CC} = 2.7\text{ V}$ | 3.3 | 1.4 | - | ns |
| | | $V_{CC} = 3.0\text{ V to }3.6\text{ V}$ | 3.3 | 1.1 | - | ns |

| Symbol | Parameter | Conditions | -40 °C to +85 °C | | | Unit |
|------------------|-------------------------------|--|------------------|---------|-----|------|
| | | | Min | Typ [1] | Max | |
| t _{su} | set-up time | An to $\overline{\text{CPAB}}$; Bn to $\overline{\text{CPBA}}$; Fig. 8 | | | | |
| | | V _{CC} = 2.3 V to 2.7 V | 1.3 | -0.1 | - | ns |
| | | V _{CC} = 2.7 V | 1.3 | -0.4 | - | ns |
| | | V _{CC} = 3.0 V to 3.6 V | 1.2 | -0.1 | - | ns |
| | | An to LEAB; Bn to LEBA; Fig. 8 | | | | |
| | | V _{CC} = 2.3 V to 2.7 V | 1.2 | 0.1 | - | ns |
| | | V _{CC} = 2.7 V | 1.1 | -0.2 | - | ns |
| | | V _{CC} = 3.0 V to 3.6 V | 1.1 | 0.3 | - | ns |
| | | $\overline{\text{CEAB}}$ to $\overline{\text{CPAB}}$; $\overline{\text{CEBA}}$ to $\overline{\text{CPBA}}$; Fig. 8 | | | | |
| | | V _{CC} = 2.3 V to 2.7 V | 0.7 | -0.4 | - | ns |
| | | V _{CC} = 2.7 V | 0.7 | -0.7 | - | ns |
| | | V _{CC} = 3.0 V to 3.6 V | 0.8 | -0.2 | - | ns |
| t _h | hold time | An to $\overline{\text{CPAB}}$; Bn to $\overline{\text{CPBA}}$; Fig. 8 | | | | |
| | | V _{CC} = 2.3 V to 2.7 V | 1.5 | 0.6 | - | ns |
| | | V _{CC} = 2.7 V | 1.8 | 0.4 | - | ns |
| | | V _{CC} = 3.0 V to 3.6 V | 1.5 | 0.4 | - | ns |
| | | An to LEAB; Bn to LEBA; Fig. 8 | | | | |
| | | V _{CC} = 2.3 V to 2.7 V | 1.2 | 0.6 | - | ns |
| | | V _{CC} = 2.7 V | 1.6 | 0.1 | - | ns |
| | | V _{CC} = 3.0 V to 3.6 V | 1.3 | 0.1 | - | ns |
| | | $\overline{\text{CEAB}}$ to $\overline{\text{CPAB}}$; $\overline{\text{CEBA}}$ to $\overline{\text{CPBA}}$; Fig. 8 | | | | |
| | | V _{CC} = 2.3 V to 2.7 V | 1.4 | 2.0 | - | ns |
| | | V _{CC} = 2.7 V | 1.7 | 0.6 | - | ns |
| | | V _{CC} = 3.0 V to 3.6 V | 1.4 | 0.4 | - | ns |
| f _{max} | maximum frequency | CPAB, CPBA; Fig. 6 | | | | |
| | | V _{CC} = 2.3 V to 2.7 V | 150 | 335 | - | MHz |
| | | V _{CC} = 2.7 V | 150 | 350 | - | MHz |
| | | V _{CC} = 3.0 V to 3.6 V | 150 | 362 | - | MHz |
| C _{PD} | power dissipation capacitance | per latch; V _I = GND to V _{CC} [3] | | | | |
| | | output enabled | - | 21 | - | pF |
| | | output disabled | - | 3 | - | pF |

- [1] Typical values are measured at T_{amb} = 25 °C.
 Typical values for V_{CC} = 2.3 V to 2.7 V are measured at V_{CC} = 2.5 V.
 Typical values for V_{CC} = 3.0 V to 3.6 V are measured at V_{CC} = 3.3 V.
- [2] t_{pd} is the same as t_{PHL} and t_{PLH};
 t_{en} is the same as t_{PZH} and t_{PZL};
 t_{dis} is the same as t_{PHZ} and t_{PLZ}.
- [3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW):
 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum(C_L \times V_{CC}^2 \times f_o)$ where:
 f_i = input frequency in MHz;
 f_o = output frequency in MHz;
 C_L = output load capacitance in pF;
 V_{CC} = supply voltage in V;
 N = number of inputs switching;
 $\sum(C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

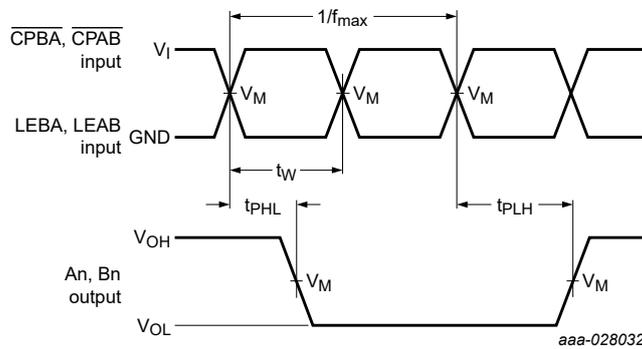
10.1. Waveforms and test circuit



Measurement points are given in [Table 8](#).

V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

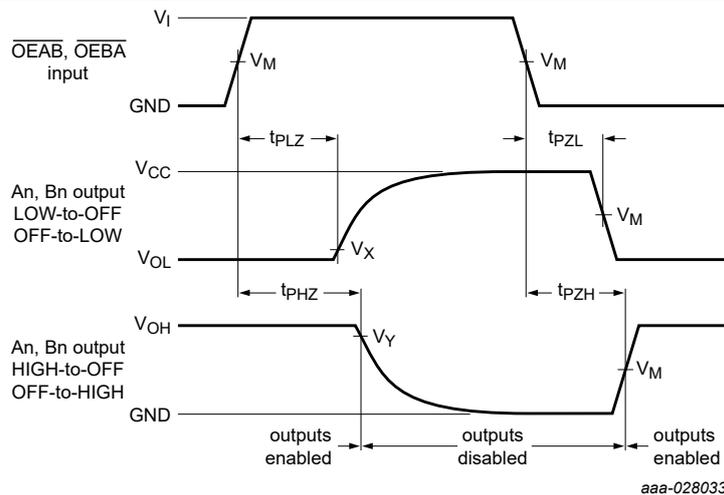
Fig. 5. The input An, Bn to output Bn, An propagation delay times.



Measurement points are given in [Table 8](#).

V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig. 6. Latch enable input LEAB, LEBA and clock input CPAB, CPBA to output Bn, An propagation delay times; pulse width and f_{max} of CPAB and CPBA



Measurement points are given in [Table 8](#).

V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig. 7. 3-state enable and disable times.

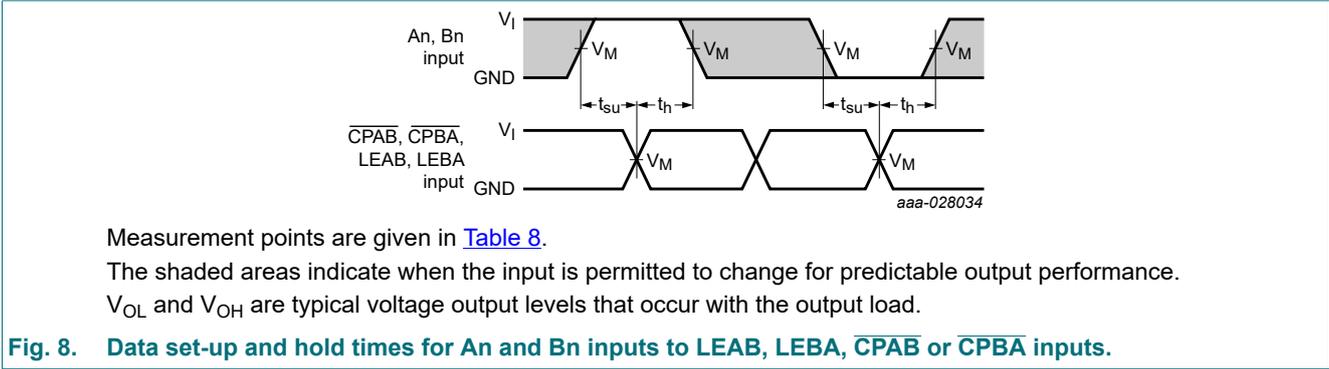
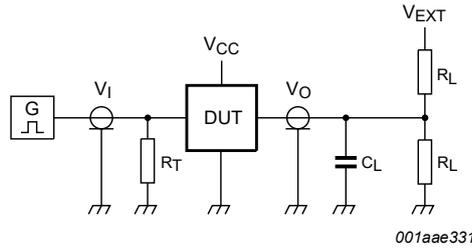
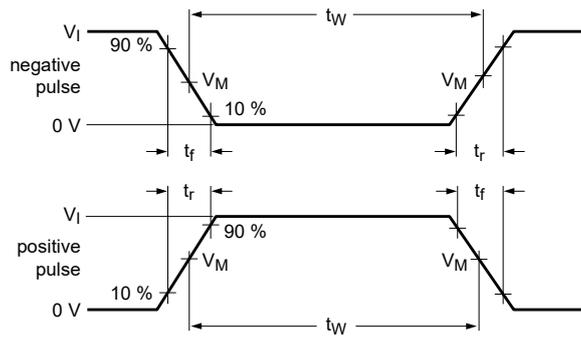


Table 8. Measurement points

| Supply voltage | Input | | Output | | |
|----------------|----------|---------------------|---------------------|---------------------------|---------------------------|
| | V_I | V_M | V_M | V_X | V_Y |
| 2.3 V to 2.7 V | V_{CC} | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ | $V_{OL} + 0.15 \text{ V}$ | $V_{OH} - 0.15 \text{ V}$ |
| 2.7 V | 2.7 V | 1.5 V | 1.5 V | $V_{OL} + 0.3 \text{ V}$ | $V_{OH} - 0.3 \text{ V}$ |
| 3.0 V to 3.6 V | 2.7 V | 1.5 V | 1.5 V | $V_{OL} + 0.3 \text{ V}$ | $V_{OH} - 0.3 \text{ V}$ |



Test data is given in [Table 9](#).

Definitions for test circuit:

R_L = Load resistance;

C_L = Load capacitance including jig and probe capacitance;

R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator;

V_{EXT} = External voltage for measuring switching times.

Fig. 9. Test circuit for measuring switching times

Table 9. Test data

| Supply voltage | Input | | Load | | V_{EXT} | | |
|----------------|----------|---------------|-------|--------------|--------------------|--------------------|--------------------|
| V_{CC} | V_I | t_r, t_f | C_L | R_L | t_{PLH}, t_{PHL} | t_{PLZ}, t_{PZL} | t_{PHZ}, t_{PZH} |
| 2.3 V to 2.7 V | V_{CC} | ≤ 2.0 ns | 30 pF | 500 Ω | open | $2 \times V_{CC}$ | GND |
| 2.7 V | 2.7 V | ≤ 2.5 ns | 50 pF | 500 Ω | open | $2 \times V_{CC}$ | GND |
| 3.0 V to 3.6 V | 2.7 V | ≤ 2.5 ns | 50 pF | 500 Ω | open | $2 \times V_{CC}$ | GND |

11. Package outline

TSSOP56: plastic thin shrink small outline package; 56 leads; body width 6.1 mm

SOT364-1

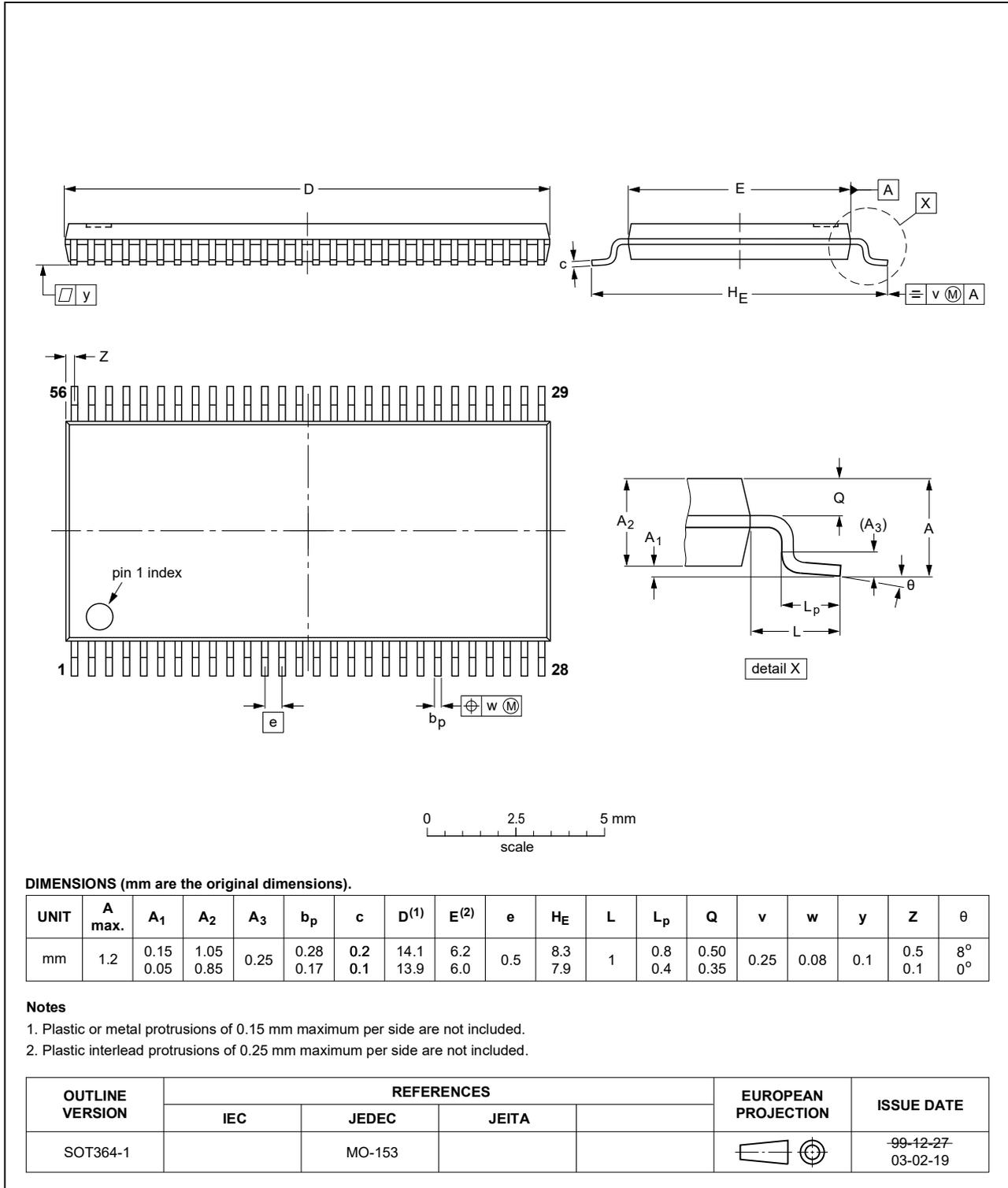


Fig. 10. Package outline SOT364-1 (TSSOP56)

12. Abbreviations

Table 10. Abbreviations

| Acronym | Description |
|---------|---|
| ANSI | American National Standards Institute |
| CDM | Charged Device Model |
| CMOS | Complementary Metal-Oxide Semiconductor |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| ESDA | ElectroStatic Discharge Association |
| HBM | Human Body Model |
| JEDEC | Joint Electron Device Engineering Council |
| TTL | Transistor-Transistor Logic |

13. Revision history

Table 11. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|------------------|---|-----------------------|---------------|------------------|
| 74ALVCH16600 v.4 | 20240704 | Product data sheet | - | 74ALVCH16600 v.3 |
| Modifications: | <ul style="list-style-type: none"> • Section 1 updated. • Section 2: ESD specification updated according to the latest JEDEC standard. • Table 4: P_{tot} total power dissipation updated. | | | |
| 74ALVCH16600 v.3 | 20180115 | Product data sheet | - | 74ALVCH16600 v.2 |
| Modifications: | <ul style="list-style-type: none"> • The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. • Legal texts have been adapted to the new company name where appropriate. | | | |
| 74ALVCH16600 v.2 | 19980924 | Product specification | - | 74ALVCH16600 v.1 |
| 74ALVCH16600 v.1 | 19980801 | Product specification | - | - |

14. Legal information

Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|--------------------------------|--------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

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